

20 V, 7.0 A, Low V_{CE(sat)} **NPN Transistor** NSS20501UW3

onsemi's e²PowerEdge family of low V_{CE(sat)} transistors are miniature surface mount devices featuring ultra low saturation voltage (V_{CE(sat)}) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are DC-DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

Features

This is a Pb–Free Device

MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Rating	Symbol	Max	Unit	
Collector-Emitter Voltage	V _{CEO}	20	Vdc	
Collector-Base Voltage	V_{CBO}	20	Vdc	
Emitter-Base Voltage	V _{EBO}	6.0	Vdc	
Collector Current - Continuous	Ic	5.0	Adc	
Collector Current - Peak	I _{CM}	7.0	Α	
Electrostatic Discharge	ESD	HBM Class 3B MM Class C		

THERMAL CHARACTERISTICS

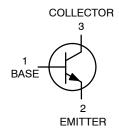
Characteristic	Symbol	Max	Unit
Total Device Dissipation, T _A = 25°C Derate above 25°C	P _D (Note 1)	875 7.0	mW mW/°C
Thermal Resistance, Junction-to-Ambient	R _{θJA} (Note 1)	143	°C/W
Total Device Dissipation, T _A = 25°C Derate above 25°C	P _D (Note 2)	1.5 11.8	W mW/°C
Thermal Resistance, Junction-to-Ambient	R _{θJA} (Note 2)	85	°C/W
Thermal Resistance, Junction-to-Lead #3	R _{θJL} (Note 2)	23	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	–55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

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1. FR-4 @ 100 mm², 1 oz copper traces. 2. FR-4 @ 500 mm², 1 oz copper traces.

20 VOLTS, 7.0 AMPS NPN LOW V_{CE(sat)} TRANSISTOR EQUIVALENT R_{DS(on)} 31 mΩ





WDFN3 CASE 506AU

MARKING DIAGRAM



VD = Specific Device Code

= Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
NSS20501UW3T2G	WDFN3 (Pb-Free)	3000/ Tape & Reel
NSS20501UW3TBG	WDFN3 (Pb-Free)	3000/ Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Typical	Max	Unit
OFF CHARACTERISTICS					•
Collector – Emitter Breakdown Voltage $(I_C = 10 \text{ mAdc}, I_B = 0)$	V _{(BR)CEO}	20	-	-	Vdc
Collector – Base Breakdown Voltage $(I_C = 0.1 \text{ mAdc}, I_E = 0)$	V _(BR) CBO	20	-	-	Vdc
Emitter – Base Breakdown Voltage ($I_E = 0.1 \text{ mAdc}, I_C = 0$)	V _{(BR)EBO}	6.0	-	_	Vdc
Collector Cutoff Current (V _{CB} = 20 Vdc, I _E = 0)	I _{CBO}	-	-	0.1	μAdc
Emitter Cutoff Current (V _{EB} = 6.0 Vdc)	I _{EBO}	-	-	0.1	μAdc
ON CHARACTERISTICS	· · · · · ·				
DC Current Gain (Note 3) $ \begin{aligned} &(I_C = 10 \text{ mA, } V_{CE} = 2.0 \text{ V}) \\ &(I_C = 500 \text{ mA, } V_{CE} = 2.0 \text{ V}) \\ &(I_C = 1.0 \text{ A, } V_{CE} = 2.0 \text{ V}) \\ &(I_C = 1.0 \text{ A, } V_{CE} = 2.0 \text{ V}) \\ &(I_C = 2.0 \text{ A, } V_{CE} = 2.0 \text{ V}) \\ &(I_C = 3.0 \text{ A, } V_{CE} = 2.0 \text{ V}) \end{aligned} $	h _{FE}	200 200 200 200 200 180	- 325 310 300	- - - -	
Collector – Emitter Saturation Voltage (Note 3) ($I_C = 0.1 \text{ A}, I_B = 0.010 \text{ A}$) ($I_C = 1.0 \text{ A}, I_B = 0.100 \text{ A}$) ($I_C = 1.0 \text{ A}, I_B = 0.010 \text{ A}$) ($I_C = 1.0 \text{ A}, I_B = 0.020 \text{ A}$) ($I_C = 2.0 \text{ A}, I_B = 0.020 \text{ A}$) ($I_C = 3.0 \text{ A}, I_B = 0.030 \text{ A}$) ($I_C = 4.0 \text{ A}, I_B = 0.400 \text{ A}$)	V _{CE(sat)}	- - - -	0.007 0.031 0.045 0.070 0.120 0.110	0.008 0.040 0.075 0.100 0.135 0.125	V
Base – Emitter Saturation Voltage (Note 3) $(I_C = 1.0 \text{ A}, I_B = 0.01 \text{ A})$	V _{BE(sat)}	-	0.760	0.900	V
Base – Emitter Turn–on Voltage (Note 3) (I _C = 2.0 A, V _{CE} = 2.0 V)	V _{BE(on)}	-	0.730	0.900	V
Cutoff Frequency ($I_C = 100 \text{ mA}$, $V_{CE} = 5.0 \text{ V}$, $f = 100 \text{ MHz}$)	f _T	150	-	_	MHz
Input Capacitance (V _{EB} = 0.5 V, f = 1.0 MHz)	Cibo	-		650	pF
Output Capacitance (V _{CB} = 3.0 V, f = 1.0 MHz)	Cobo	-		70	pF
SWITCHING CHARACTERISTICS					
Delay (V _{CC} = 15 V, I _C = 750 mA, I _{B1} = 15 mA)	t _d	_	-	90	ns
Rise ($V_{CC} = 15 \text{ V}, I_{C} = 750 \text{ mA}, I_{B1} = 15 \text{ mA}$)	t _r	-	-	100	ns
Storage (V _{CC} = 15 V, I _C = 750 mA, I _{B1} = 15 mA)	t _s	-	-	500	ns
Fall (V _{CC} = 15 V, I _C = 750 mA, I _{B1} = 15 mA)	t _f	_	-	100	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Pulsed Condition: Pulse Width = 300 μsec, Duty Cycle ≤ 2%.

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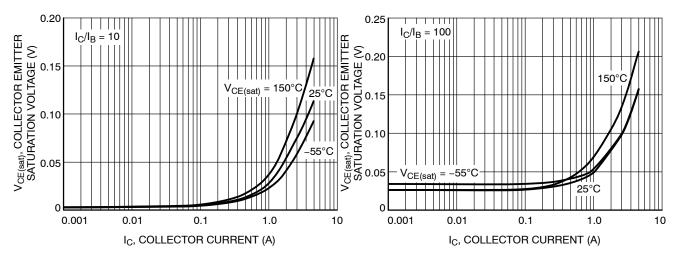


Figure 1. Collector Emitter Saturation Voltage vs. Collector Current

Figure 2. Collector Emitter Saturation Voltage vs. Collector Current

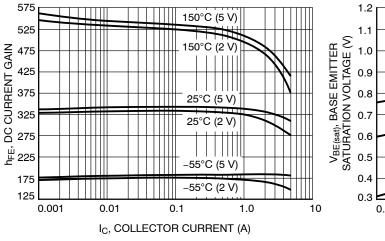


Figure 3. DC Current Gain vs. Collector Current

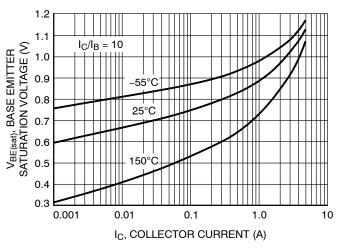


Figure 4. Base Emitter Saturation Voltage vs.
Collector Current

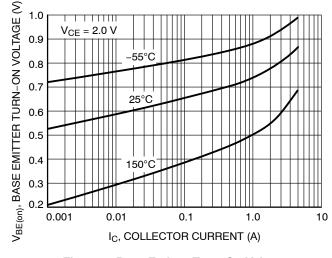


Figure 5. Base Emitter Turn-On Voltage vs.
Collector Current

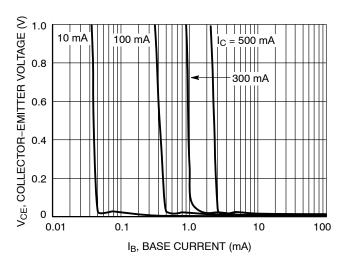


Figure 6. Saturation Region

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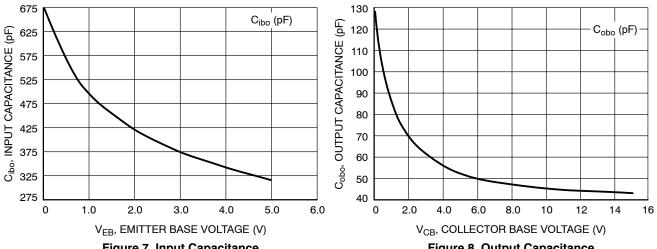


Figure 7. Input Capacitance

Figure 8. Output Capacitance

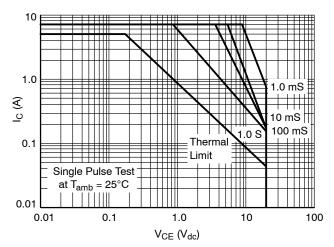


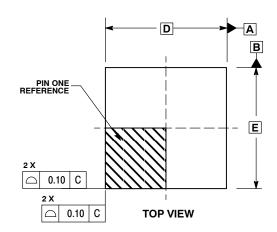
Figure 9. Safe Operating Area

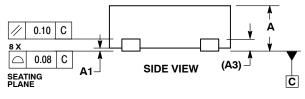


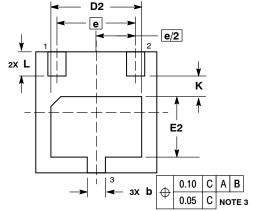
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DATE 18 AUG 2016

SCALE 4:1







BOTTOM VIEW

NOTES

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994 .
 CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSION b APPLIES TO PLATED TERMINAL AND IS
- MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS
- THE TERMINALS.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.70	0.75	0.80	0.028	0.030	0.031
A1	0.00		0.05	0.000		0.002
A3		0.20 REF			0.008 REF	
b	0.25	0.30	0.35	0.010	0.012	0.014
D		2.00 BSC			0.079 BSC	;
D2	1.40	1.50	1.60	0.055	0.059	0.063
E		2.00 BSC			0.079 BSC	;
E2	0.90	1.00	1.10	0.035	0.039	0.043
е		1.30 BSC			0.051 BSC	;
K		0.35 REF			0.014 REF	
L	0.35	0.40	0.45	0.014	0.016	0.018

GENERIC MARKING DIAGRAM*

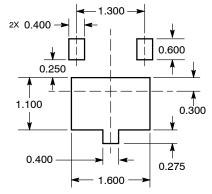


XX = Specific Device Code М = Date Code

*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " ■", may or may not be present.

SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	WDFN3 2X2, 1.3P		PAGE 1 OF 1	

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